

MOSFET NOTES

MOSFET is an active device which can control flow of current through it.

Full form METAL oxide Semiconductors ~~FEET~~ Field Effect transistor.

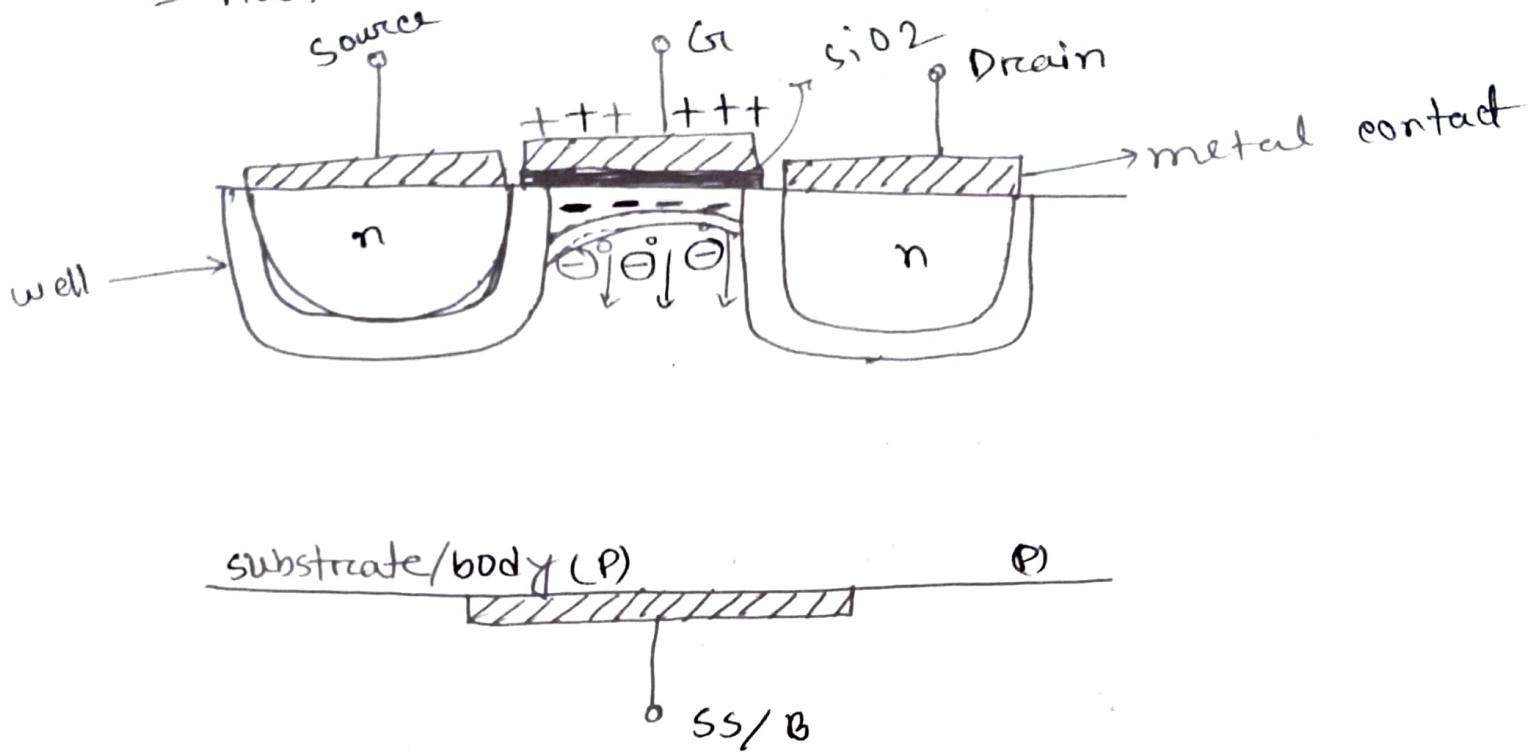
It is of two types → Depletion type MOSFET
→ Enhancement type MOSFET

Depletion type MOSFET branches into n channel and p channel.

Enhancement type MOSFET branches into n channel and p channel.

MOSFET NOTES

* Constructions of & working of Enhancement type MOSFET
E-MOS.



For P_{-}
In case of P ^{channel} ~~type~~, E-MOS, substrate is of n type
and source and drain are P type

The gate terminal is not directly connected with the body, it is over a very thin layer of SiO_2

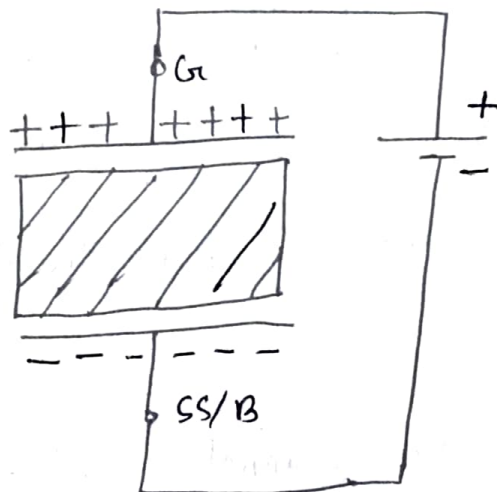
There is no channel initially between Drain & source.

Now let's see how the channel is formed

We know, substrate is of p-type material, where majority charge carrier is holes and minority charge carrier ~~are~~ is electron. Charge neutrality is maintained, i.e. mobile charge carrier = immobile ions.

Now we will make the gate terminal more positive with respect of to ss.

Suppose, the gate and ~~ss~~ substrate terminals are the two parallel plate of a capacitor and the SiO_2 acts as die-electric material like the following -



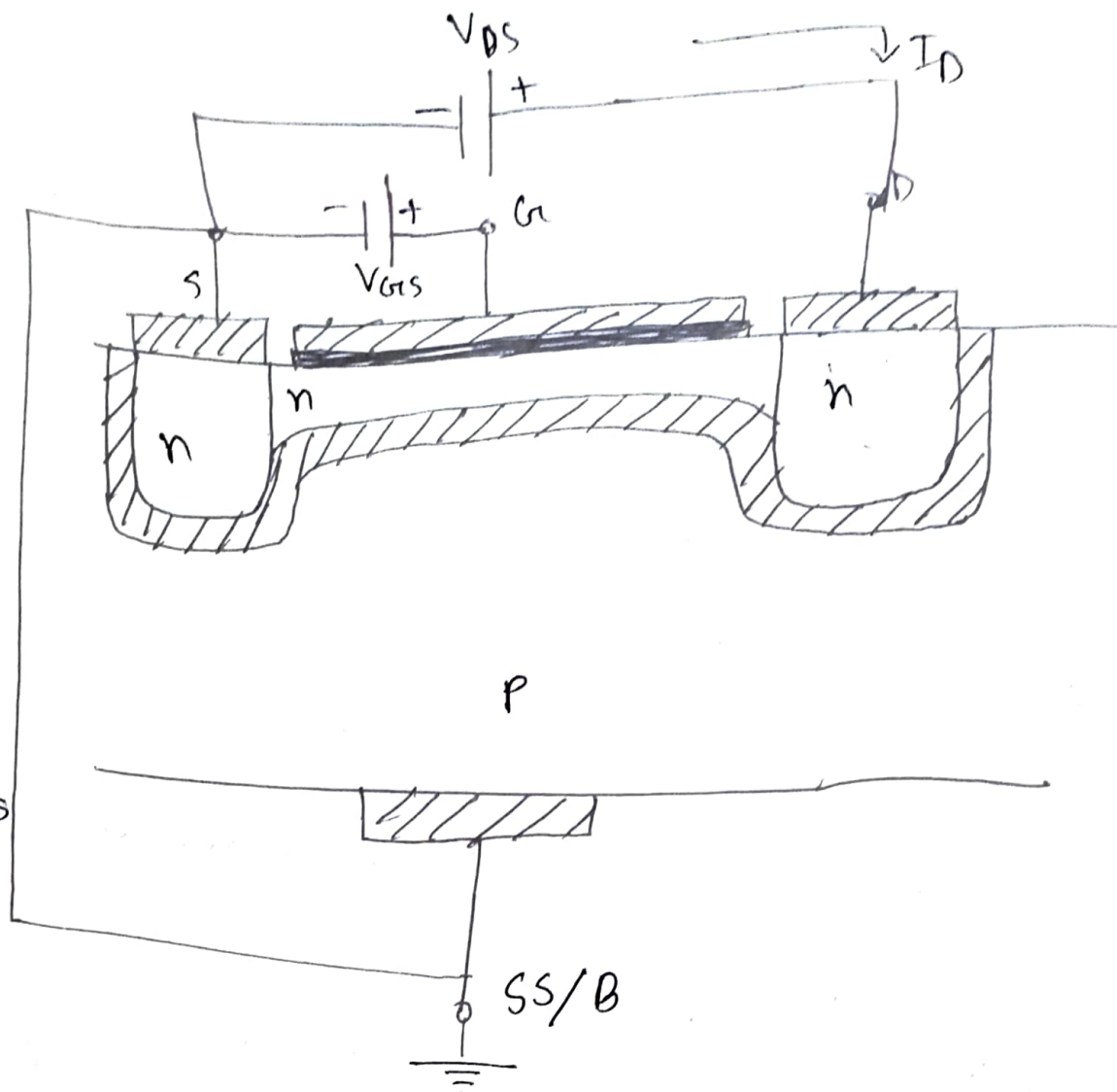
~~that~~ After applying voltage, positive charge will accumulate over gate terminal, negative charges will accumulate to the substrate

when we increase V_{GS} then the minority charge carrier of substrate gets accumulated near the contact. When we further increase V_{GS} , uncovering of negative ions will take place and the surface near the contact will become more negative. This is called inversion of p-type material to n-type material near contact of the body.

Now channel will be formed between source and drain.

* So, when $V_{GS} > 0$, inversion happened, p-type material changed into n-type and conductive channel have been formed between Drain & Source.

• $V_{GS} \uparrow \rightarrow$ channel depth will be increased.



Most of the time s and SS/B terminal are shorted,

Now, if V_{GS} is ^{greater} ~~greater~~ than threshold voltage V_T , then current I_D will flow through channel from source to drain,

Effect of V_{DS} on depletion layer:

To find it we have find, V_{GD}

$$V_G - V_{GS} + V_{DS} = V_D$$

$$V_G - V_D = V_{GS} - V_{DS}$$

$$V_{GD} = V_{GS} - V_{DS}$$

Case 1: $V_{DS} = 0V$

$$V_{GD} = V_{GS}$$

that means if no bias is applied to between Drain & source, then the $V_{GD} = V_{GS}$ so, the depletion region will be same.

~~V_{GS}~~ let, $V_T = 1V$

$$V_{GS} = 2V = V_{GD}$$

So, channel width will be corresponding to

$$V_{GS} - V_T = 2 - 1 = 1V$$

$$CH_1 \rightarrow 1V$$

if $V_{GS} = 3V = V_{GD}$,

$$\therefore CH_2 \rightarrow 2V$$

So, $CH_2 > CH_1$

Case 2: $V_{DS} > 0V$

~~$V_{GD} \downarrow$~~ $V_{GD} = V_{GS} - V_{DS}$

$V_{DS} \uparrow$

So, V_{GD} will be lower
 $V_{GD} \neq V_{DS}$

this implies that Drain is becoming more positive, so, the depletion region will no longer be uniform.

the depletion region will be increased near drain terminal.

Case 2: we will make,

$$V_{DS} = V_{GS} - V_T$$

$$\begin{aligned}\therefore V_{GD} &= V_{GS} - V_{DS} \\ &= V_{GS} - V_{GS} + V_T \\ &= V_T\end{aligned}$$

The channel will become extremely narrow near drain

This condition is known as pinch off.

V_{DS} is V_{DSsat}

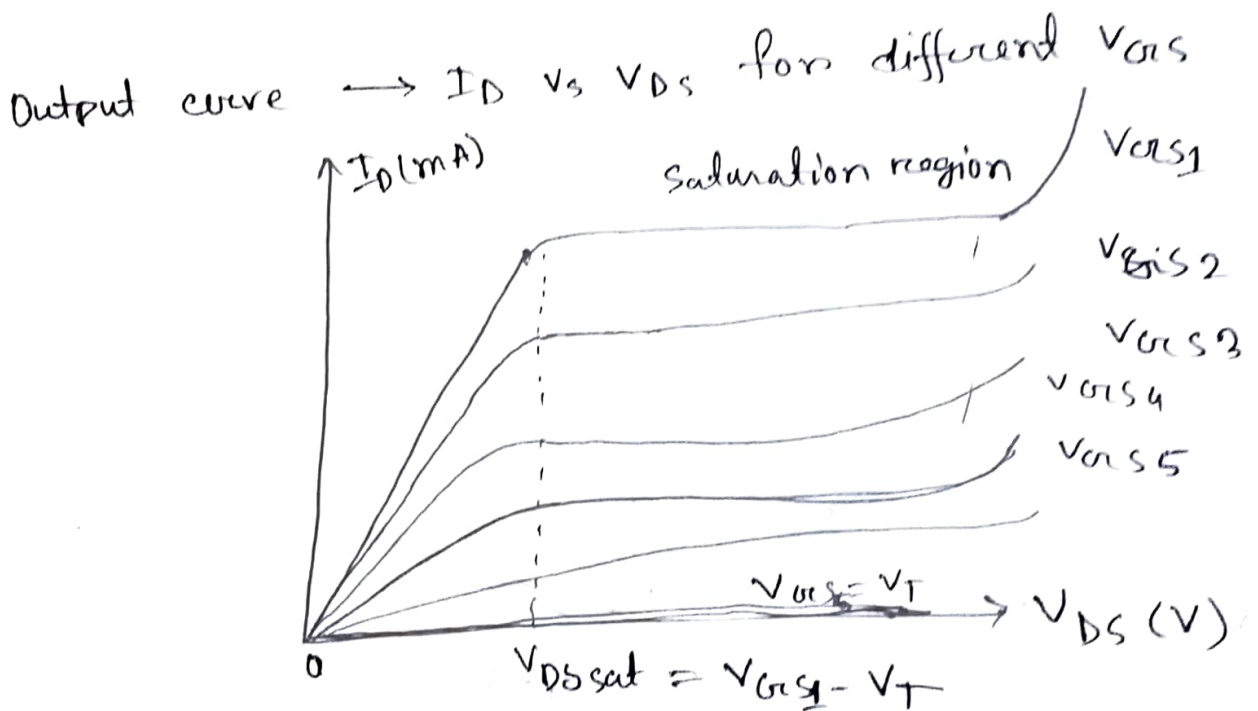
if we increase V_{DS} more, current I_D will remain constant.

Output Curve & Transfer Curve

Output current = I_D

Output voltage = V_{DS}

input voltage
controlled variable V_{GS}



V_T = threshold voltage and constant K is given

case 1: $V_{GS} > V_T$, so, there will be channel between D & S

$$V_{eff} = V_{GS1} - V_T$$

V_{eff} affected the width of channel

$V_{DS} = 0V$, ~~so~~ so, now current flows ~~through~~
from D to S

When $V_{DS} = V_{DSsat}$

$I_D = \text{constant (pinch off)}$

Case 2: $\uparrow V_{GS} \Rightarrow$ channel width $\uparrow\uparrow$

So, conductivity increases

So, Resistance decreases

$$V_{GS2} < V_{GS1}$$

$$P_2 < P_1$$

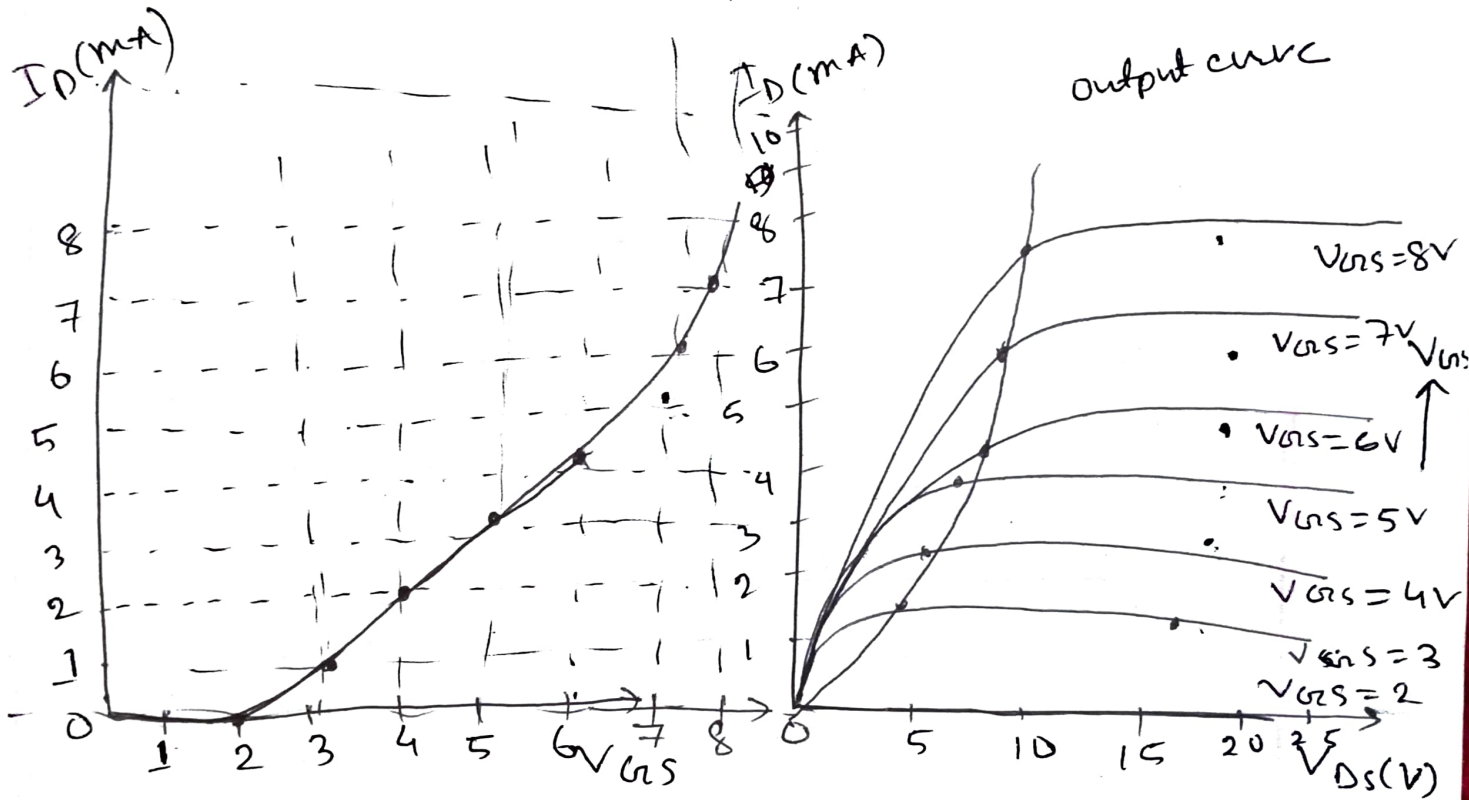
$$R_2 > R_1$$

$$\text{slope}_2 < \text{slope}_1$$

$$I_D = K(V_{GS} - V_T)^2$$

Q

Transfer Characteristics of E-MOSFET



$$V_T = 2V \quad K = 0.27 \times 10^{-13} \text{ A/V}^2$$

math

1. ~~For~~ Firstly $\&$ EMOS or DMOS ଏବଂ ନିର୍ଦ୍ଧାରିତ
ସାଧାରଣ ସୂତ୍ର ।

For EMOS, $I_D = K(V_{GS} - V_T)^2$

For D-MOS, $I_D = I_{DSS} \left(1 - \frac{V_{GS}}{V_P}\right)^2$

Example 7.9 :

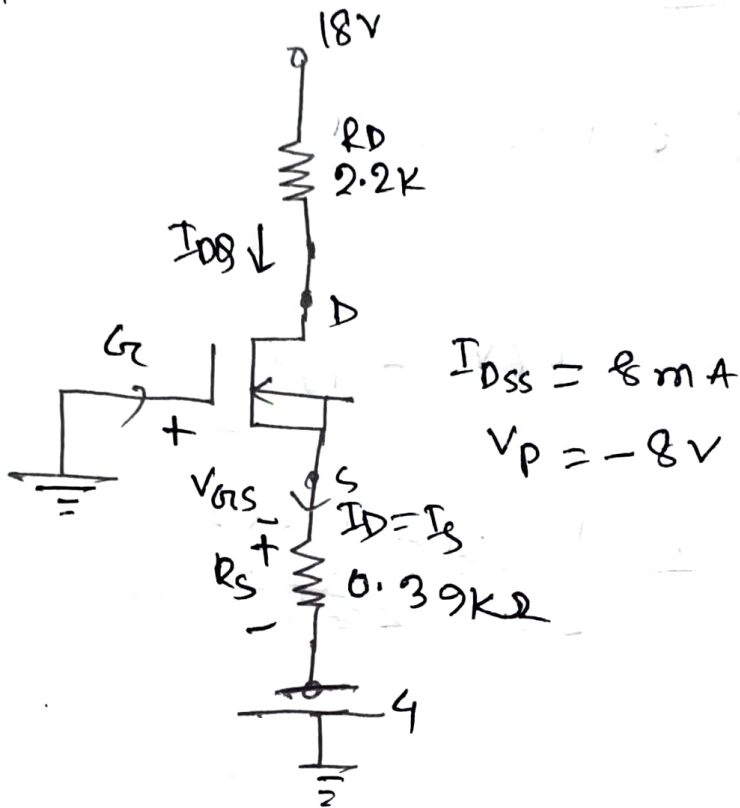
~~V_{GS} =~~

$$V_{GS} = -I_D R_S$$

$\&$

Math

*



We know,

$$I_D = I_{DSS} \left(1 - \frac{V_{GS}}{V_P} \right)^2$$

Here,

$$I_G \approx 0 \text{ A}$$

$$V_G = 0 \text{ V}$$

$$I_D = I_S$$

So,

$$-V_{GS} - I_D R_S + 4 = 0$$

$$V_{GS} = 4 - I_D R_S \longrightarrow (1)$$

Putting the value of V_{cs} , from (ii) we get

$$I_D = I_{DSS} \left(1 - \frac{4 - I_D R_S}{V_P} \right)^2$$

$$\Rightarrow I_D = 8 \left(1 - \frac{4 - I_D \times 0.39}{-8} \right)^2$$

$$\Rightarrow I_D = 8 \left(1 + \frac{4}{8} + \frac{I_D \times 0.39}{8} \right)^2$$

$$\Rightarrow I_D = 8 \left(1 + \frac{1}{2} - 0.04875 I_D \right)^2$$

$$\Rightarrow I_D = 8 \left(\frac{3}{2} 1.5 - 0.04875 I_D \right)^2$$

$$\Rightarrow I_D = 8 \left\{ (1.5)^2 - 2 \times 1.5 \times 0.04875 I_D + 2.3765 \times 10^{-3} I_D^2 \right\}$$

$$\Rightarrow I_D = 8 \left[2.25 - 0.14625 I_D + 2.3765 \times 10^{-3} I_D^2 \right]$$

$$\Rightarrow I_D = 18 - 1.17 I_D - 0.019012 I_D^2$$

$$\Rightarrow 0.01912 I_D^2 + 2.17 I_D - 18 = 0$$

$$\text{Solving, } I_D = 7.7638 \text{ mA}$$

✓

So,

$$V_{GS} = 4 - I_D \times R_S = 4 - 0.972 \text{ V}$$

Again, Apply KVL at output loop -

$$18 - I_D R_D - V_{DS} - I_D R_S + 4 = 0$$

$$V_{DS} = 18 - I_D R_D - I_D R_S - 4$$

$$\therefore V_{DS} = -6.108$$

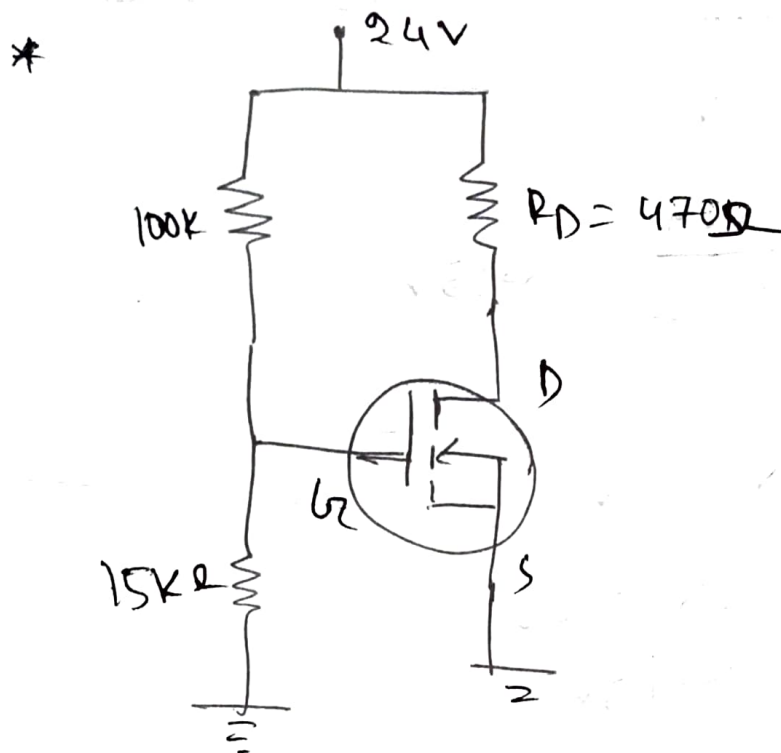
$$V_D - V_S = V_{DS}$$

$$V_S = V_D - V_{DS}$$

$$= 18 - I_D \times R_D - V_{DS}$$

$$= 18 - 0$$

$$= 7.02764 \text{ V}$$



* V_{DS}

* V_{GS}

Here,

$$I_{D(ON)} = 500 \text{ mA}$$

$$V_{GS(ON)} = 10 \text{ V}$$

$$V_T = 1 \text{ V}$$

$$V_{DS} = ? \quad V_{GS} = ?$$

W. know

$$I_{D(ON)} = k (V_{GS(ON)} - V_T)^2$$

$$k = \frac{I_{D(ON)}}{(V_{GS(ON)} - V_T)^2}$$

$$= \frac{500 \text{ mA}}{(10 - 1)^2} = 6.173 \text{ mA/V}^2$$

* Here, $V_S = 0V$

$$V_{GS} = \frac{15 \times 24}{15 + 100} = 3.13V$$

$$\begin{aligned} V_{GS} &= V_G - V_S \\ &= 3.13 - 0 \\ &= 3.13V \end{aligned}$$

Again,

$$I_D = K(V_{GS} - V_T)^2$$

$$= 6.173 \times 10^{-3} (3.13 - 1)^2 = 28mA$$

Applying KVL at output loop,

$$24 - I_D R_D - V_{DS} = 0$$

$$\begin{aligned} \Rightarrow V_{DS} &= 24 - I_D R_D \\ &= 10.84V \end{aligned}$$